

Miniaturised photonic front-end for the next generation of space SAR applications

T. Mengual^a, Vanessa C. Duarte^a, V. Polo^a, M. A. Piqueras^a, P. Sanchis^b, A. Brimont^b, D. Zurita^b, B. Chmielak^c, S. Suckow^c, A.

Giesecke^c, E. Matarazzo^d, L. DiPalma^d, D. Maiarelli^d, H. Wang^e and P. G. Huggard^e.

^aDAS Photonics, Camino de Vera, s/n Edificio 8F, 46022 Valencia, Spain

^bNanophotonics Technology Center, UPV, Camino de Vera s/n, 46022 Valencia, Spain

^cAMO GmbH, Otto-Blumenthal-Str. 25, 52074 Aachen, Germany

^dAIRBUS Italia S.p.A., Via dei Luxardo 22-24 - 00156 Rome, Italy

^eRAL Space, STFC Rutherford Appleton Laboratory, Ox11 0QX, Didcot, UK

Introduction:

There is a natural trade-off between spacecraft size and functionality in all current satellite applications. In case of the next generation of Earth Observation satellites, one of the key development areas is synthetic aperture radar (SAR) antennas, where expected progress will be to increase the operating bandwidth and miniaturization. In this scenario, the use of photonic integrated circuits (PIC) technology in the beamforming network, in combination with an optical fibre harness, are obvious key enabling technologies for future SAR instruments.

Optically implemented true time delay (TTD) beamforming structures achieve orders-of-magnitude improvements in size and mass, provides easy routing thanks to wavelength-division multiplexing, antenna and RF system integration due to the EMI-free characteristic of the optical fibre and a reduction of the risks associated with the in-orbit antenna deployment. Additionally, the inherent broadband characteristic of photonic technology, related to the transport and processing of RF signals, simplifies the beamforming network and signal distribution design for different frequencies, applications and missions.

1. Application scenario

Three missions that that could benefit from the proposed technology have been identified which are based on reduction of mass and volume achievable with PIC TTD technology.

Parameter	Mission #1 (small platforms)	Mission #2 (satellites in formation)	Mission #3 (large platforms)
Operating frequency	X-band, 9.6 GHz	X-band, 9.6 GHz	X-band, 9.6 GHz
Signal bandwidth	500 MHz	400 MHz	800 MHz
Relative Signal Bandwidth	5.2%	4.2%	8.3%
Instrument Mass (including antenna)	30 kg	30 kg	250 kg
Peak Transmitted Power	1 kW	30 W	2.8 kW
Access Area	20° - 45°	20° - 45°	15° - 55°
Spatial Resolution	1 m - 3 m	1 m - 3 m	0.5 m
Swath width	5 km - 8 km	5 km - 8 km	5 km - 8 km
Noise Equivalent σ^0	-20 dB @ 1m res. -30 dB @ 3m res.	-25 dB	-15 dB

Table1. Reference requirements for the proposed application scenario missions.

2. Architecture description

Multi-beam photonic beamformer sub-populated demonstrator sufficient to assess the main technical functionalities:

- RF to optical (E/O) conversion
- A PIC implementing TTD
- Optical to RF (O/E) conversion
- Associated optical distribution
- Antenna elements

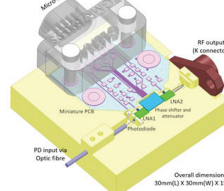


Figure 2. Prototype of the X-band photoreceiver module

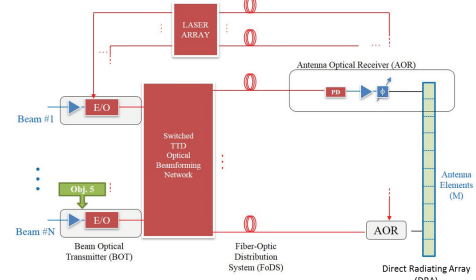


Figure 1. Scheme of the photonic beamformer. RF elements are shown in blue, optical in red.

3. Photonic integrated circuit implementing TTD lines

The proposed optical beamforming network with TTD characteristic is constructed by aggregating elementary PIC-based 8x8 beamforming network which can control the delay of up to eight signals simultaneously and to route and combine them to a specific beamforming port.

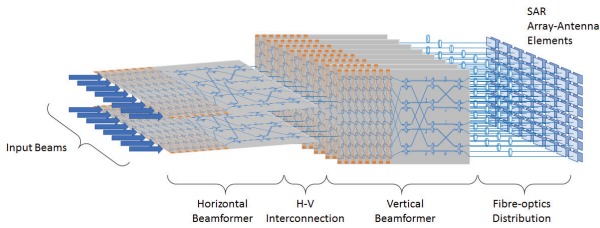


Figure 3. 3D aggregation of elementary 8x8 beamforming network PICs to construct the complete SAR beamformer

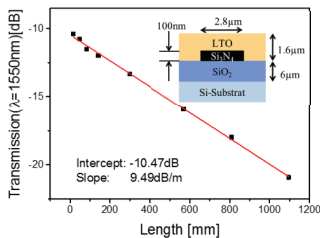


Figure 4. Measured transmission vs waveguide length (at wavelength of 1550nm). Fitted line, red, has a slope of 9 dB/m (propagation losses). The intercept with the y-axis yields a loss of 5.2 dB per fiber-chip coupler. Inset: Ultra-low loss photonic waveguide cross-section

- Designed and validated a PIC manufacturing process based on low loss Si_3N_4 technology.
- An efficient fibre-to-chip assembly process, required for a high number of input/output ports, has been developed.
- The different photonic integrated building blocks (BB) required to implement the elementary PIC have been designed.

4. Sub-array antenna element

An antenna array module in X band, whose electrical requirements will be satisfied over the whole operating frequency range, has been designed.

Item	Requirements
Operative Frequency	X-band (9.6 GHz)
Frequency Bandwidth	600 MHz
Polarization	Dual orthogonal linear (H, V)
Sub-array onfiguration	Linear (8 elements)
Element Spacing	$0.85 \lambda_0 @ 9.9 \text{ GHz}$
Subarray Spacing	$0.70 \lambda_0 @ 9.9 \text{ GHz}$
Return Loss	> 18 dB (Target)
Insertion Loss	< 1.6 dB (Target)
Power handling	Compatible with SAR mission

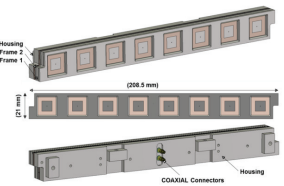


Figure 5. 3D sketch of the sub-array antenna element

Table2. Antenna requirements

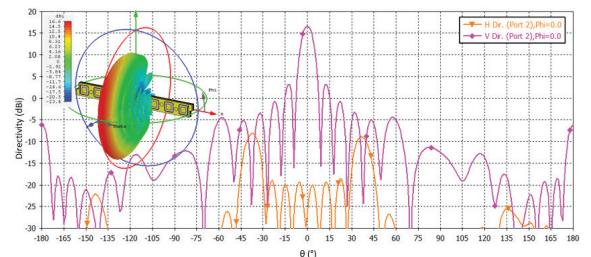


Figure 6. Simulated radiation patterns (directivity) of the AES shown in Figure 5 at 9.6 GHz in the horizontal plane, port H excited. Inset: 3D views of the radiation patterns.

CONCLUSIONS:

The advances in design and fabrication of a miniaturised photonic front-end for the next generation of space SAR applications has been reported which incorporates new features such as, centralised signal processing and a truly broadband frequency operation approach thanks to the multi-beam TTD reconfigurable beamforming architecture.

Contact: Teresa Mengual

eMail: tmengual@dasphotonics.com

Project website: <http://www.retinah2020.eu>